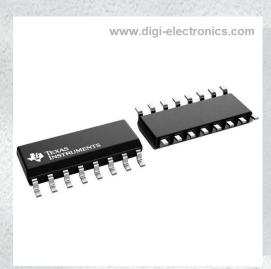


SN74LS175NE4 Datasheet



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DiGi Electronics Part Number SN74LS175NE4-DG

Manufacturer Texas Instruments

Manufacturer Product Number SN74LS175NE4

Description IC FF D-TYPE SNGL 4BIT 16DIP

Detailed Description Flip Flop 1 Element D-Type 4 Bit Positive Edge 16-D

IP (0.300", 7.62mm)



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Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
SN74LS175NE4	Texas Instruments
Series:	Product Status:
74LS	Active
Function:	Type:
Master Reset	D-Type
Output Type:	Number of Elements:
Complementary	1
Number of Bits per Element:	Clock Frequency:
4	40 MHz
Max Propagation Delay @ V, Max CL:	Trigger Type:
25ns @ 5V, 15pF	Positive Edge
Current - Output High, Low:	Voltage - Supply:
400μA, 8mA	4.75V ~ 5.25V
Current - Quiescent (Iq):	Operating Temperature:
18 mA	0°C ~ 70°C (TA)
Mounting Type:	Supplier Device Package:
Through Hole	16-PDIP
Package / Case:	
16-DIP (0.300", 7.62mm)	

Environmental & Export classification

8542.39.0001

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	Not Applicable
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	

SN74LS175NE4 Texas Instruments IC FF D-TYPE SNGL 4BIT 16DIP

SN54174, SN54175, SN54LS174, SN54LS175, SN54S174, SN54S175, SN74174, SN74LS174, SN74LS175, SN74LS175, SN74S174, SN74LS175, SN74S175, SN7

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'174, 'LS174, 'S174 . . . HEX D-TYPE FLIP-FLOPS '175, 'LS175, 'S175 . . . QUADRUPLE D-TYPE FLIP-FLOPS

- '174, 'LS174, 'S174 Contain Six Flip-Flops with Single-Rail Outputs
- '175, 'LS175, 'S175 Contain Four Flip-Flops with Double-Rail Outputs
- Three Performance Ranges Offered: See Table Lower Right
- Buffered Clock and Direct Clear Inputs
- Individual Data Input to Each Flip-Flop
- Applications include: Buffer/Storage Registers

Shift Registers
Pattern Generators

description

These monolithic, positive-edge-triggered flip-flops utilize TTL circuitry to implement D-type flip-flop logic. All have a direct clear input, and the '175, 'LS175, and 'S175 feature complementary outputs from each flip-flop.

Information at the D inputs meeting the setup time requirements is transferred to the Q outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the positive-going pulse. When the clock input is at either the high or low level, the D input signal has no effect at the output.

These circuits are fully compatible for use with most TTL circuits.

FUNCTION TABLE (EACH FLIP-FLOP)

	NPUTS		OUTPUTS					
CLEAR CLOCK		D	Q	ā۲				
L	L X		L	Н				
н	1	н	Н	L				
н	1	L	L	Н				
н	L	х	a ₀	$\bar{\alpha}_0$				

H = high level (steady state)

L = low level (steady state)

X = irrelevant

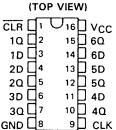
↑ = transition from low to high level

 $\mathbf{Q}_{\mathbf{Q}}$ = the level of \mathbf{Q} before the indicated steady-state input conditions were established.

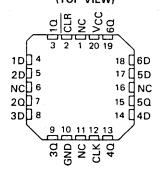
† = '175, 'LS175, and 'S175 only

	TYPICAL	TYPICAL
TYPES	MAXIMUM	POWER
11723	CLOCK	DISSIPATION
	FREQUENCY	PER FLIP-FLOP
'174, ' 175	35 MHz	38 mW
'LS174, 'LS175	40 MHz	14 mW
'S174, 'S175	110 MHz	75 mW

SN54174, SN54LS174, SN54S174 . . . J OR W PACKAGE SN74174 . . . N PACKAGE SN74LS174, SN74S174 . . . D OR N PACKAGE

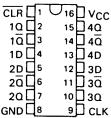


SN54LS174, SN54S174 . . . FK PACKAGE (TOP VIEW)

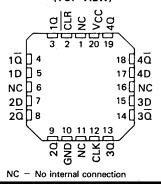


SN54175, SN54LS175, SN54S175 . . . J OR W PACKAGE SN74175 . . . N PACKAGE SN74LS175, SN74S175 . . . D OR N PACKAGE

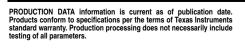
(TOP VIEW)



SN54LS175, SN54S175 . . . FK PACKAGE (TOP VIEW)



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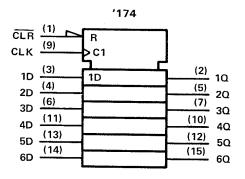


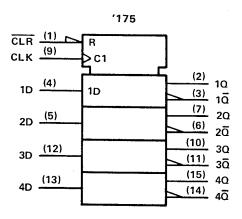
1

SN54174, SN54175, SN54LS174, SN54LS175, SN54S174, SN54S175, SN74174, SN74175, SN74LS174, SN74LS175, SN74S175, HEX/QUADRUPLE D-TYPE FLIP-FLOPS WITH CLEAR

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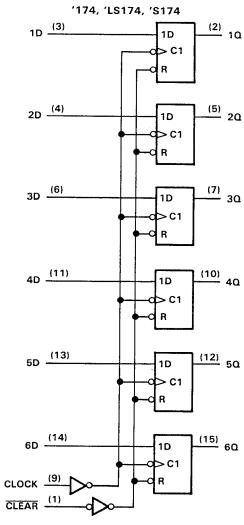
logic symbols†

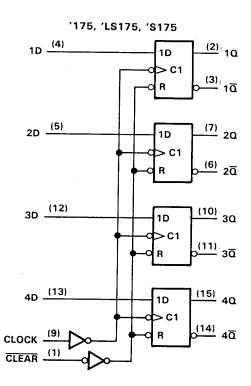




[†]These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, N, and W packages.

logic diagrams (positive logic)





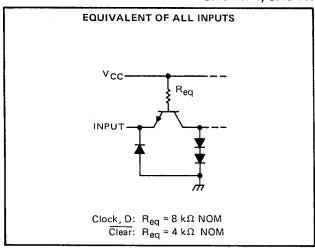
Pin numbers shown are for D, J, N, and W packages.

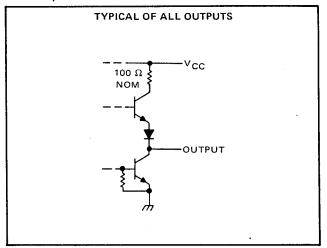


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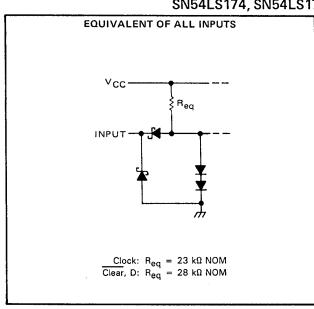
schematics of inputs and outputs

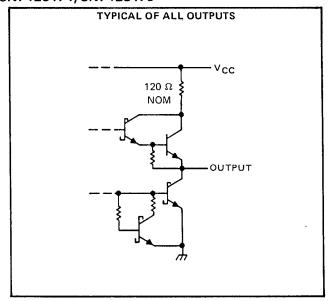
SN54174, SN54175, SN74174, SN74175



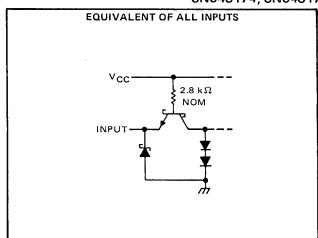


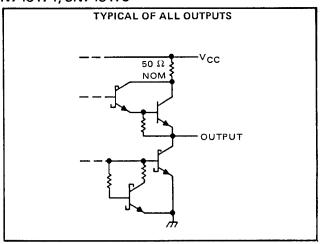
SN54LS174, SN54LS175, SN74LS174, SN74LS175





SN54S174, SN54S175, SN74S174, SN74S175







SN54174, SN54175, SN74174, SN74175 HEX/QUADRUPLE D-TYPE FLIP-FLOPS WITH CLEAR

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Operating free-air temperature range: SN54174, SN54175 Circuits SN74174, SN74175 Circuits 0°C to 70°C Storage temperature range \ldots -65° C to 150° C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN54	174, SN	54175	SN74	LINIT		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}		4.5	5	5.5	4.75	5	5.25	٧
High-level output current, IOH				-800			-800	μΑ
Low-level output current, IOL				16			16	mA
Clock frequency, f _{clock}		0		25	0		25	MHz
Width of clock or clear pulse, t _W		20			20			ns
Setup time, t _{SU}	Data input	20			20			ns
Setup time, tsu	Clear inactive-state	25			25			ns
Data hold time, t _h		5			5			ns
Operating free-air temperature, TA		-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS [†]	MIN	TYP‡	MAX	UNIT		
VIH	High-level input voltage		2			V		
VIL	Low-level input voltage				0.8	>		
VIK	Input clamp voltage	$V_{CC} = MIN$, $I_1 = -12 \text{ mA}$						
Vон	High-level output voltage	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = 0.8 V, I _{OH} = -800 μA	2.4	3.4		٧		
VOL	Low-level output voltage	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = 0.8 V, I _{OL} = 16 mA		0.2	0.4	٧		
Ιį	Input current at maximum input voltage	V _{CC} = MAX, V _I = 5.5 V			1	mA		
ΊΗ	High-level input current	V _{CC} = MAX, V _I = 2.4 V			40	μΑ		
IL	Low-level input current	V _{CC} = MAX, V _I = 0.4 V			-1.6	mA		
1	Chart in it automates	SN SN	54' -20		-57	^		
los	Short-circuit output current §	V _{CC} = MAX	74' –18		-57	mA		
laa	Cumple guerrant	VCC = MAX. See Note 2 '17	74	45	65			
1CC	Supply current	V _{CC} = MAX, See Note 2 /17	75	30	45	mA		

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device

NOTE 2: With all outputs open and 4.5 V applied to all data and clear inputs, ICC is measured after a momentary ground, then 4.5 V, is applied to clock.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f _{max}	Maximum clock frequency		25	35		MHz
^t PLH	Propagation delay time, low-to-high-level output from clear (SN54175, SN74175 only)	C _L = 15 pF,		16	25	ns .
^t PHL	Propagation delay time, high-to-low-level output from clear	R _L = 400 Ω, See Note 3		23	35	ns
^t PLH	Propagation delay time, low-to-high-level output from clock	See Note 3		20	30	ns
tPHL	Propagation delay time, high-to-low-level output from clock			24	35	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



 $^{^{\}ddagger}$ All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}$ C.

[§]Not more than one output should be shorted at a time.

SN54LS174, SN54LS175, SN74LS174, SN74LS175 HEX/QUADRUPLE D-TYPE FLIP-FLOPS WITH CLEAR

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recommended operating conditions

		SN	154LS1	74	SN	74	UNIT	
		SN	N54LS1	75	SI	75		
_		MIŃ	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V _{CC}		4.5	5	5.5	4.75	5	5.25	٧
High-level output current, IOH				-400			-400	μΑ
Low-level output current, IOL				4			. 8	mA
Clock frequency, f _{clock}		0		30	0		30	MHz
Width of clock or clear pulse, t _W		20			20			ns
Setup time, t _{SU}	Data input	20			20			ns
Setup time, tsu	Clear inactive-state	25			25			ns
Data hold time, t _h		5			5			ns
Operating free-air temperature, T _A		-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER TEST CONDITIONS [†]		_	N54LS N54LS		1	174 175	UNIT			
					MIN	TYP‡	MAX	MIN	TYP‡	MAX	
VIH	High-level input voltage				2			2			٧
VIL	Low-level input voltage						0.7			0.8	V
VIK	Input clamp voltage	V _{CC} = MIN,	I ₁ = -18 mA				-1.5			-1.5	V
V _{OH}	High-level output voltage	V _{CC} = MIN, V _{IL} = V _{IL} max,	V _{IH} = 2 V, I _{OH} = -400 μ,	Α.	2.5	3.5		2.7	3.5		٧
VoL	Low-level output voltage	V _{CC} = MIN, V _{IL} = V _{IL} max		I _{OL} = 4 mA		0.25	0.4		0.25 0.35	0.4	V
łį	Input current at maximum input voltage	V _{CC} = MAX,	V ₁ = 7 V				0.1			0.1	mA
Чн	High-level input current	V _{CC} = MAX,	V _I = 2.7 V				20			20	μА
IIL.	Low-level input current	V _{CC} = MAX,	V ₁ = 0.4 V				-0.4			-0.4	mA
los	Short-circuit output current §	V _{CC} = MAX			-20		-100	-20		-100	mA
Icc	Supply current	V _{CC} = MAX,	See Note 2	'LS174 'LS175		16 11	26 18	 	16 11	26 18	mA

¹ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

PARAMETER	TEST CONDITIONS		'LS174					
PARAMETER		MIN	TYP	MAX	MIN	TYP	MAX	UNIT
f _{max} Maximum clock frequency		30	40		30	40		MHz
tplH Propagation delay time, low-to-high-level output from clear	C _L = 15 pF,					20	30	ns
tphl Propagation delay time, high-to-low-level output from clear	$R_1 = 2 k\Omega$,		23	35		20	30	ns
tplH Propagation delay time, low-to-high-level output from clock	See Note 3		20	30		13	25	ns
tpHL Propagation delay time, high-to-low-level output from clock			21	30		16	25	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



 $^{^{\}dagger}$ \$\frac{1}{4}\$All typical values are at $V_{CC} = 5 \text{ V}$, $T_{A} = 25^{\circ}\text{C}$.

 $[\]S$ Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTE 2: With all outputs open and 4.5 V applied to all data and clear inputs, I_{CC} is measured after a momentary ground, then 4.5 V, is applied to clock.

SN54S174, SN54S175, SN74S174, SN74S175 HEX/QUADRUPLE D-TYPE FLIP-FLOPS WITH CLEAR

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)	 					7	′ V
Input voltage							
Operating free-air temperature range: SN54S174, SN54S175 Circuits	 					–55°C to 125	î°C
SN74S174, SN74S175 Circuits	 					. 0°C to 70)°C
Storage temperature range						-65°C to 150	

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN54S	174, SN	54S175	SN74S	74S175	LINIT	
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}		4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH				-1			-1	mA
Low-level output current, IOL				20			20	mA
Clock frequency, f _{clock}		0		75	0		75	MHz
Pulso width +	Clock	7			7			
Pulse width, t _W	Clear	10			10			ns
Catua tima t	Data input	5			5			
Setup time, t _{SU}	Clear inactive-state	5			5			ns
Data hold time, t _h		3			3			ns
Operating free-air temperature, TA		-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS [†]		MIN	ТҮР‡	MAX	UNIT
VIH	High-level input voltage			2			V
VIL	Low-level input voltage					0.8	V
VIK	Input clamp voltage	V _{CC} = MIN, I _I = -18 mA				-1.2	V
V	High level autout vale	V _{CC} = MIN, V _{IH} = 2 V,	SN54S'	2.5	3.4		V
VOH	High-level output voltage	V _{IL} = 0.8 V, I _{OH} = -1 mA	SN74S'	2.7	3.4] '
V	Low level output valtage	V _{CC} = MIN, V _{IH} = 2 V,				0.5	V
VOL	Low-level output voltage	V _{IL} = 0.8 V, I _{OL} = 20 mA				0.5	ľ
Ц	Input current at maximum input voltage	$V_{CC} = MAX, V_{I} = 5.5 V$				1	mA
Ιιн	High-level input current	V _{CC} = MAX, V ₁ = 2.7 V				50	μΑ
1 ₁ L	Low-level input current	V _{CC} = MAX, V _I = 0.5 V				-2	mA
los	Short-circuit output current §	V _{CC} = MAX		-40		-100	mA
	0 1	Was = MAY Con Note 2	′174		90	144	
lcc_	Supply current	V _{CC} = MAX, See Note 2		60	96	mA	

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f _{max}	Maximum clock frequency		75	110		MHz
tPLH	Propagation delay time, low-to-high-level $\overline{\mathbb{Q}}$ output from clear (SN54S175, SN74S175 only)	C _L = 15 pF,		10	15	ns
tPHL.	Propagation delay time, high-to-low-level Q output from clear	$R_L = 280 \Omega$, See Note 3		13	22	ns
^t PLH	Propagation delay time, low-to-high-level output from clock	See Note 3		8	12	ns
†PHL	Propagation time, high-to-low-level output from clock			11.5	17	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



 $[\]ddagger$ All typical values are at V_{CC} = 5 V, T_A = 25°C. § Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTE 2: With all outputs open and 4.5 V applied to all data and clear inputs, I_{CC} is measured after a momentary ground, then 4.5 V, is



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PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
JM38510/07105BEA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07105BEA	Samples
JM38510/07105BFA	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07105BFA	Samples
JM38510/07106BEA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07106BEA	Samples
JM38510/30106B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30106B2A	Samples
JM38510/30106BEA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30106BEA	Samples
JM38510/30106BFA	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30106BFA	Samples
JM38510/30107B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30107B2A	Samples
JM38510/30107BEA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30107BEA	Samples
JM38510/30107BFA	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30107BFA	Samples
M38510/07105BEA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07105BEA	Samples
M38510/07105BFA	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07105BFA	Samples
M38510/07106BEA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07106BEA	Samples
M38510/30106B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Non-Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30106B2A	Samples
M38510/30106BEA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30106BEA	Samples
M38510/30106BFA	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30106BFA	Samples
M38510/30107B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30107B2A	Samples



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Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Sample
M38510/30107BEA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30107BEA	Samples
M38510/30107BFA	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30107BFA	Samples
SN54LS174J	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS174J	Samples
SN54LS175J	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS175J	Samples
SN54S174J	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S174J	Samples
SN54S175J	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S175J	Samples
SN74LS174D	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI	0 to 70	LS174	
SN74LS174DR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS174	Samples
SN74LS174N	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS174N	Samples
SN74LS174NSR	ACTIVE	SOP	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS174	Samples
SN74LS175D	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI	0 to 70	LS175	
SN74LS175DR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS175	Sample
SN74LS175N	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS175N	Sample
SN74LS175NE4	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS175N	Samples
SN74LS175NSR	ACTIVE	SOP	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS175	Sample
SN74S175D	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	S175	Sample
SN74S175N	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74S175N	Sample
SNJ54LS174FK	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS 174FK	Sample
SNJ54LS174J	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS174J	Samples
SNJ54LS174W	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS174W	Samples



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Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SNJ54LS175FK	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS 175FK	Samples
SNJ54LS175J	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS175J	Samples
SNJ54LS175W	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS175W	Samples
SNJ54S174J	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S174J	Samples
SNJ54S174W	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S174W	Samples
SNJ54S175J	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S175J	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.





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OTHER QUALIFIED VERSIONS OF SN54LS174, SN54LS175, SN54S175, SN74LS174, SN74LS175, SN74S175:

• Catalog: SN74LS174, SN74LS175, SN74S175

Military: SN54LS174, SN54LS175, SN54S175

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

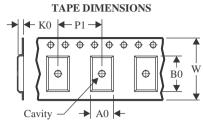


PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS174DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS174NSR	SOP	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
SN74LS175DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS175NSR	SOP	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1



PACKAGE MATERIALS INFORMATION

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*All dimensions are nominal

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	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
	SN74LS174DR	SOIC	D	16	2500	353.0	353.0	32.0
	SN74LS174NSR	SOP	NS	16	2000	356.0	356.0	35.0
	SN74LS175DR	SOIC	D	16	2500	340.5	336.1	32.0
١	SN74LS175NSR	SOP	NS	16	2000	356.0	356.0	35.0



PACKAGE MATERIALS INFORMATION

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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
JM38510/07105BFA	W	CFP	16	25	506.98	26.16	6220	NA
JM38510/30106B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
JM38510/30106BFA	W	CFP	16	25	506.98	26.16	6220	NA
JM38510/30107B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
JM38510/30107BFA	W	CFP	16	25	506.98	26.16	6220	NA
M38510/07105BFA	W	CFP	16	25	506.98	26.16	6220	NA
M38510/30106B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
M38510/30106BFA	W	CFP	16	25	506.98	26.16	6220	NA
M38510/30107B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
M38510/30107BFA	W	CFP	16	25	506.98	26.16	6220	NA
SN74LS174N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS174N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS175N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS175N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS175NE4	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS175NE4	N	PDIP	16	25	506	13.97	11230	4.32
SN74S175D	D	SOIC	16	40	507	8	3940	4.32
SN74S175N	N	PDIP	16	25	506	13.97	11230	4.32
SN74S175N	N	PDIP	16	25	506	13.97	11230	4.32
SNJ54LS174FK	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54LS174W	W	CFP	16	25	506.98	26.16	6220	NA
SNJ54LS175FK	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54LS175W	W	CFP	16	25	506.98	26.16	6220	NA

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Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com